

CMS Experiment at the LHC, CERN Data recorded: 2015-Jul-08 01:23:54.766464 GMT Run / Event / LS: 251168 / 484861 / 1 Performance of the CMS Cathode Strip Chamber endcap muon detectors in Run 2



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CMS:

Muon is our middle name









MEI/I electronics upgrade motivation

- MEI/I chambers are closest CSC's to the interaction point (I.6 < |η| < 2.4): face the largest muon flux
- segmented into 2 sub-chambers (MEI/Ia & MEI/Ib), by a gap along the cathode strips - different wire spacing / orientation in the two regions
- MEI/Ia strips were triple-ganged every 16 strips → caused a 3-fold ambiguity in triggering and reconstruction. Chosen to reduce number of readout channels; since Run I added 2 on-chamber readout electronics boards.

100 cm



Readout MEI/I electronics upgraded **on chambers**, in **peripheral crates**, and in **front end crates**



New board acronyms:

- OTMB Optical Trigger MotherBoard
- ODMB Optical Data MotherBoard
- PPIB Patch Panel Interface Board
- DCFEB Digital Cathode Front-End Board
- LVDB7 Low Voltage Distribution Board (7 DCFEB version)
- LVMB7 Low Voltage Monitor Board (7 DCFEB version)
- S6 Spartan-6 mezzanine board

72 chambers were extracted, re-instrumented, tested, & reinstalled

Upgrade of on-chamber MEI/I electronics

$\mathsf{CFEB} \to \mathsf{DCFEB}$

(Digital Cathode Front End Board)

- Replace old (analog) CFEBs, which were transferred to new ME4/2 chambers
- Over 2400 individual electronics components
- flash ADCs replace switch capacitor array
- fully digital pipeline: effectively no deadtime, better able to handle pile-up
- improved FPGA (Virtex 6)
- optical data read out
- 5 CFEBs \rightarrow 7 DCFEBs (no triple-ganging in ME1/1a)
- 554 boards (incl. spares) produced & tested
- extensive radiation testing

Other new electronics

- new low voltage distribution and monitoring boards to handle increased consumption / channels from 7 DCFEBs
- Anode local charge track board equipped with Spartan 6 FPGA to handle larger rates.



Upgrade of peripheral crate MEI/I electronics $DMB \rightarrow ODMB$ (Optical DAQ Mother Board) Two main tasks, both related to DCFEBs: LVMB (low Trigger, timing and control distribution listributi (control) • Data acquisition. Voltag ranslato translato /buffers optical readout. CCB (clock) DCFEBs (TTC) отмв DCFEBs (data) TMB → OTMB (Optical Trigger Mother Board) Optical Trigger Mother Board (OTMB) • Constructs cathode track segments and performs matching (trigger) NEW buffers DCFEBs (TTC) to an MEW/k Opticad rifeigger Mother Board (O Voltage regulators/ DDU/PC (data) filters • New mezzanine board with upgraded FPGA \rightarrow improved trigger logic. Receives data optically. LCT reconstruction efficiency in ME1 Eff. 0.8 efficiency in TMB 2013 **p₋(**μ)>10 GeV/c Simulation 0.6 with current TMB, ME1/a on 0.4 pileup=100 current TMB, ME1/a off new TMB 0 GeV/c 0.2 0 0.8 2.2 1.2 2 2.4 1.4 1.6 1.8 ent TMB, ME1/a

MEI/I and ME4/2 chambers were tested thoroughly before (re)installation

- comprehensive suite of tests: basic functionality, connectivity, trigger logic, data quality & noise levels
- use generated pulses and cosmic rays
- 4-weeks of high voltage monitoring & gas leak tests
- all connectivity and data quality tests repeated in situ
- included in global CMS cosmic ray data taking
- a few problems identified and repaired: bad boards, loose connections, etc.





Sample data quality plot: strips occupancy.

Event display of a triggered cosmic ray muon detected in 6 layers of strips.



Run 2 CSC performance



First stable I 3 TeV collisions June 3, 2015







The reconstructed hit occupancy

is uniform across all stations

- Problematic chambers typically produce low or high occupancy.
- One chamber (ME-3/2/22) had been disabled because of a faulty board, since replaced.
- Otherwise occupancy is good in all chambers.



Minus endcap:

Global Y (cm)

500



The hit efficiency has improved since Run I



13

The hit position resolution has improved in MEI/Ia (2.1<| η |<2.5)

The difference between the position of a reconstructed hit in layer 3 and the position obtained by fitting a segment with hits from the other 5 layers.

- The improvement in resolution in MEI/Ia is primarily from the removal of triple-ganging the strips. This reduces the capacitance, which in turn decreases the front-end noise.
- Resolution in all CSC stations varies from 50 - 140 μm, depending on the station. Corresponds to resolution in Φ of ~0.1 mrad.



The chambers are timed-in

Timing study For each station, find the clock delay that maximizes # local tracks in correct time window.

The interaction point time of reconstructed hits is centered at 0, as expected for timed-in chambers. The timing and synchronization accuracy is at the level of Run 1.



Readiness of entire muon system in Run 2

The muon reconstruction efficiency

has improved by 1-2%

- Efficiency to pass tight muon ID is measured with Z→µµ tag and probe study.
- The Run I and Run 2 muon reconstruction algorithms are applied to the same set of Run I data.
- Improved performance is mainly due to new muonspecific tracking iterations.
- Improvement is independent of pseudorapidity (shown here) and number of vertices (not shown).



region of CSC coverage

First look at 13 TeV data:





The history of particle physics for the first time at $\sqrt{s=13}$ TeV

- Dedicated triggers target various resonances.
- Data around resonance peaks well-described by fits.



Φ(1020

Events / 3 MeV

20 pb⁻¹ (13 TeV)

∫f₁σ₁²+f₂σ₂² = 15 MeV μ^{μ⁺μ} I < 1.25

CMS Preliminary

The CMS Cathode Strip Chambers are ready for Run 2

muon detected by CSC's

- A great effort of many people over the past 2+ years has gone into preparing the CSC's for Run 2.
- Improved MEI/I electronics
 remove ambiguity from triple-ganging
 of strips in MEI/Ia, reduce deadtime
 by storing data in digital pipeline.
- New ME4/2 chambers provide 4station redundancy → reduce fake rates and improve efficiency.
- The CSC's have been timed in and are taking data with **high efficiency**.
- Performance of CSC's in early stages of Run 2 is **improved** from Run 1.

Run 251244 Event 204117665 $\sqrt{s} = 13 \text{ TeV}$ e_1 $p_{T} = 63.3 \text{ GeV}$ **η** = 1.2 p_T = 58.7 GeV n = 1.8 $pp \rightarrow ZZ \rightarrow 2e2\mu$ m_{uu}= 91.1 GeV $m_{ee} = 88.2 \text{ GeV}$ $m_{4\ell} = 208.9 \text{ GeV}$ μ_2 $p_{T} = 36.1 \text{ GeV}$ $p_{T} = 25.5 \text{ GeV}$ η = 0.98 $\eta = 0.20$

We expect many interesting events like this one in the months/years ahead!